

IRS2153D(S)

SELF-OSCILLATING HALF-BRIDGE DRIVER IC

Features

- Integrated 600V Half-Bridge Gate Driver
- CT, RT programmable oscillator
- 15.4V Zener Clamp on VCC
- Micropower Startup
- Non-latched shutdown on CT pin (1/6th VCC)
- Internal bootstrap FET
- Excellent Latch Immunity on All Inputs & Outputs
- +/- 50V/ns dV/dt immunity
- ESD Protection on All Pins
- 8-lead SOIC or PDIP package
- 1.1 usec (typ.) internal deadtime

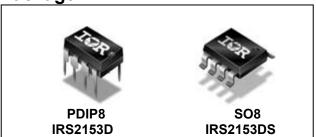
Description

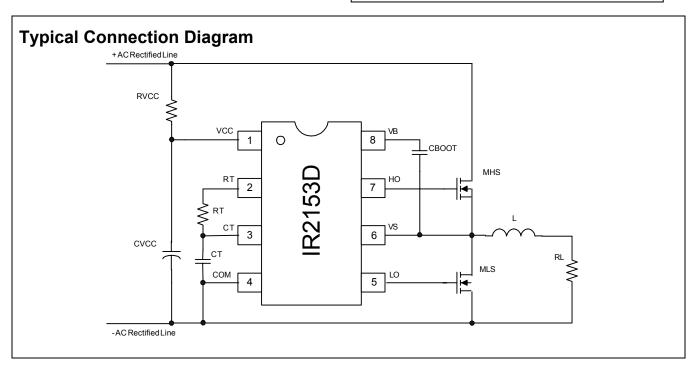
The IRS2153D is based on the popular IR2153 self-oscillating half-bridge gate driver IC using a more advanced silicon platform, and incorporates a high voltage half-bridge gate driver with a front end oscillator similar to the industry standard CMOS 555 timer. HVIC and latch immune CMOS technologies enable rugged monolithic construction. The output driver features a high pulse current buffer stage designed for minimum driver cross-conduction. Noise immunity is achieved with low di/dt peak of the gate drivers.

Product Summary

VOFFSET	600V Max
Duty Cycle	50%
Trise/tfall	120/50ns typ.
Vclamp	15.4V typ.
Deadtime	1.1us typ.

Package





Please note that this datasheet contains advanced information, which could change before the product is released to production



Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM, all currents are defined positive into any lead. The Thermal Resistance and Power Dissipation ratings are measured under board mounted and still air conditions

Parameter				
Symbol	Definition	Min.	Max.	Units
V _B	High Side Floating Supply Voltage	-0.3	625	V
Vs	High Side Floating Supply Offset Voltage	V _B - 25	V _B + 0.3	V
V _{HO}	High-Side Floating Output Voltage	V _S – 0.3	V _B + 0.3	V
V _{LO}	Low-Side Output Voltage	-0.3	V _{CC} + 0.3	V
I _{RT}	R _T Pin Current	-5	5	mA
V _{RT}	R _T Pin Voltage	-0.3	V _{CC} + 0.3	V
V _{CT}	C _T Pin Voltage	-0.3	V _{CC} + 0.3	V
Icc	Supply Current (Note 1)		20	mA
IOMAX	Maximum allowable current at LO and HO due to external power transistor Miller effect.	-500	500	
dV _S /dt	Allowable Offset Voltage Slew Rate	-50	50	V/ns
P _D	Maximum Power Dissipation @ T _A ≤ +25°C, 8-Pin DIP		1.0	W
P _D	Maximum Power Dissipation @ T _A ≤ +25°C, 8-Pin SOIC		0.625	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, 8-Pin DIP		85	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, 8-Pin SOIC		128	°C/W
TJ	Junction Temperature	-55	150	
Ts	Storage Temperature	-55	150	°C
T _L	Lead Temperature (Soldering, 10 seconds)		300	

Note 1: This IC contains a zener clamp structure between the chip V_{CC} and COM which has a nominal breakdown voltage of 15.4V. Please note that this supply pin should not be driven by a DC, low impedance power source greater than the V_{CLAMP} specified in the Electrical Characteristics section.



Recommended Operating Conditions

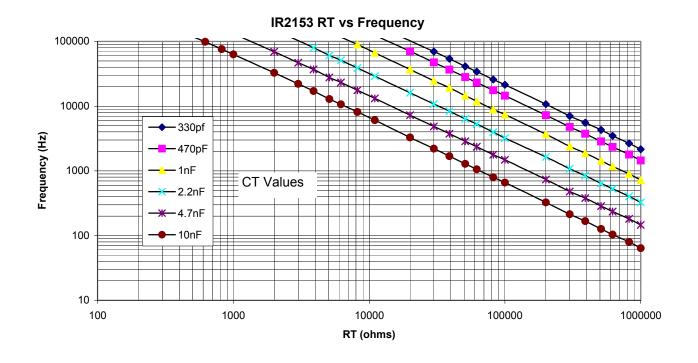
For proper operation the device should be used within the recommended conditions.

	Parameter			
Symbol	Definition	Min.	Max.	Units
V _{BS}	High Side Floating Supply Voltage	V _{CC} - 0.7	V_{CLAMP}	V
Vs	Steady State High Side Floating Supply Offset Voltage	-3.0 (Note 2)	600	V
V _{CC}	Supply Voltage	V _{CCUV} + +0.1V	V _{CC} CLAMP	V
Icc	Supply Current	(Note 3)	5	mA
TJ	Junction Temperature	-40	125	°C

- Note 2: Care should be taken to avoid output switching conditions where the V_S node flies inductively below ground by more than 5V.
- **Note 3:** Enough current should be supplied to the V_{CC} pin of the IC to keep the internal 15.6V zener diode clamping the voltage at this pin.

Recommended Component Values

Parameter				
Symbol	Component	Min.	Max.	Units
R⊤	Timing Resistor Value	10		kΩ
Ст	C _T Pin Capacitor Value	330		pF



IRS2153D



Electrical Characteristics

VBIAS (VCC, VBS) = 14V, CT = 1 nF, VS=0V and TA = 25° C unless otherwise specified. The output voltage and current (VO and IO) parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

Symbol	Definition	Min	Тур	Max	Units	Test Conditions
Low Volt	age Supply Characteristics					
V _{CCUV} +	Rising V _{CC} Undervoltage Lockout Threshold	10.2	10.8	11.5		
V _{CCUV} -	Falling V _{CC} Undervoltage Lockout Threshold	8.3	8.8	9.4	V	
Vccuvhys	V _{CC} Undervoltage Lockout Hysteresis	1.6	2.0	2.4		
I _{QCCUV}	Micropower Startup V _{CC} Supply Current		130	155	μA	$V_{CC} \le V_{CCUV}$
Iqcc	Quiescent VCC Supply Current		800	1000	μA	
Icc	VCC Supply Current		1.8		mA	$R_T = 36.9k\Omega$
V _{CC CLAMP}	V _{CC} Zener Clamp Voltage	14.8	15.4	16.0	V	I _{CC} = 5mA
Floating	Supply Characteristics		•			
I _{QBS}	Quiescent V _{BS} Supply Current		60	80	μA	
V _{BSUV+}	V _{BS} Supply Undervoltage Positive Going Threshold	8.5	9.0	9.5	V	
V _{BSUV} -	V _{BS} Supply Undervoltage negative Going Threshold	7.6	8.0	8.6		
I _{LK}	Offset Supply Leakage Current			50	μΑ	V _B = V _S = 600V
Oscillato	r I/O Characteristics	•			•	
fosc	Oscillator Frequency	18.6	19.2	19.8	kHz	$R_T = 36.9k\Omega$
		88	93	100		$R_T = 7.43k\Omega$
d	R _T Pin Duty Cycle		50		%	f _o < 100kHz
I _{CT}	C _T Pin Current		0.02	1.0	μА	
I _{CTUV}	UV-Mode C _T Pin Pulldown Current	0.20	0.30	0.6	mA	V _{CC} = 7V
V _{CT+}	Upper C _T Ramp Voltage Threshold		9.32			
V _{CT} -	Lower C _T Ramp Voltage Threshold		4.66		V	
V _{CTSD}	C _T Voltage Shutdown Threshold	2.2	2.32	2.4		
V_{RT+}	High-Level R _T Output Voltage, V _{CC} - V _{RT}		10	50	mV	$I_{RT} = -100 \mu A$
			100	300	mV	$I_{RT} = -1mA$
$V_{RT ext{-}}$	Low-Level R _T Output Voltage		10	50	mV	I _{RT} = 100μA
			100	300	mV	I _{RT} = 1mA
V_{RTUV}	UV-Mode R⊤ Output Voltage		0	100	mV	$V_{CC} \leq V_{CCUV^{\perp}}$
V _{RTSD}	SD-Mode R _T Output Voltage, V _{CC} - V _{RT}		10	50	mV	$I_{RT} = -100 \mu A,$ $V_{CT} = 0 V$
			100	300	mV	I _{RT} = -1mA, V _{CT} = 0V

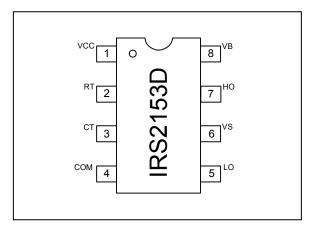


Electrical Characteristics

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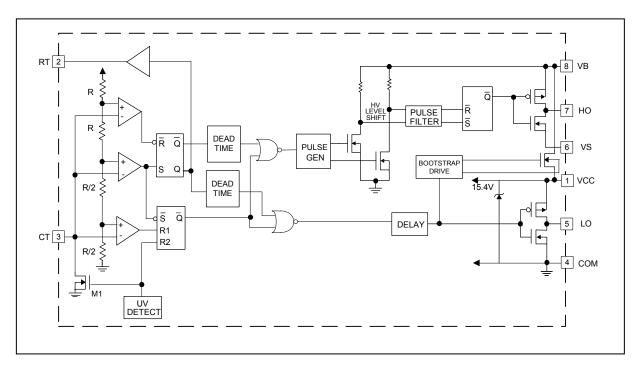
Symbol	Definition	Min	Тур	Max	Units	Test Conditions
Gate Driver Output Characteristics						
V _{OH}	High-Level Output Voltage		VCC			I _O = 0A
V_{OL}	Low-Level Output Voltage		COM			I _O = 0A
V _{OL_UV}	UV-Mode Output Voltage		COM			$I_O = 0A,$ $V_{CC} \le V_{CCUV}$
t _r	Output Rise Time		120	220		
t _f	Output Fall Time		50	80	nsec	
t _{sd}	Shutdown Propagation Delay		350			
t _d	Output Deadtime (HO or LO)	0.75	1.11	1.5	μsec	
IO+	Output source current		180		mA	
IO-	Output sink current		260			
Bootstrap FET Characteristics						
VB_ON	VB when the bootstrap FET is on		13.7		V	
IB_CAP	VB source current when FET is on	5	55		mA	CBS=0.1uF
IB_10V	VB source current when FET is on	8	12			VB=10V

Lead Definitions



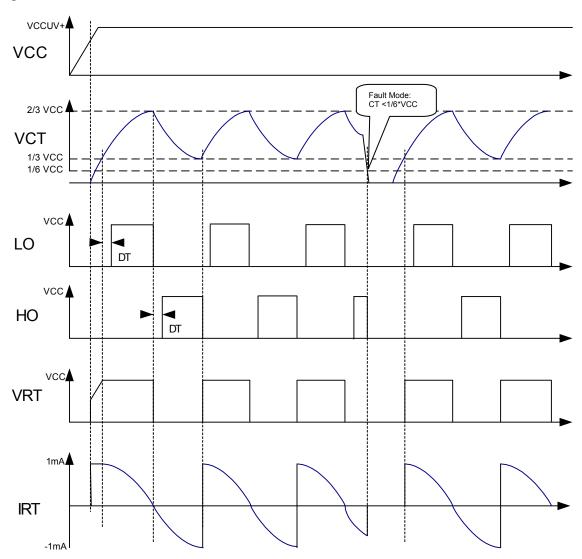
	Lead		
Symbol	Description		
V _{CC}	Logic and internal gate drive supply voltage		
R _T	Oscillator timing resistor input		
Ст	Oscillator timing capacitor input		
COM	IC power and signal ground		
LO	Low-side gate driver output		
Vs	High voltage floating supply return		
НО	High-side gate driver output		
V _B	High side gate driver floating supply		

Functional Block Diagram



Timing Diagram

Operating Mode



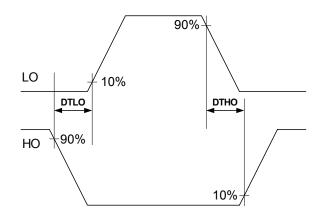
Switching Time Waveform

90% tf

10%

HO LO

Deadtime Waverform



Functional Description

Under-voltage Lock-Out Mode (UVLO)

The under-voltage lockout mode (UVLO) is defined as the state the IC is in when VCC is below the turn-on threshold of the IC. The IRS2153D under voltage lock-out is designed to maintain an ultra low supply current of less than 155uA, and to guarantee the IC is fully functional before the high and low side output drivers are activated. During under voltage lock-out mode, the high and low-side driver outputs HO and LO are both low.

Supply voltage

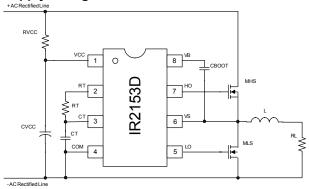


Fig. 1 Typical Connection Diagram

Fig. 1 shows an example of supply voltage. The start-up capacitor (C_{VCC}) is charged by current through supply resistor (R_{VCC}) minus the start-up current drawn by the IC. This resistor is chosen to provide sufficient current to supply the IRS2153D from the DC bus. C_{VCC} should be large enough to hold the voltage at Vcc above the UVLO threshold for one half cycle of the line voltage as it will only be charged at the peak, typically 0.1uF. It will be necessary for RVCC to dissipate around 1W.

The use of a two diode charge pump made of DC1, DC2 and CVS (Fig. 2) from the half bridge (VS) is also possible however the above approach is simplest and the dissipation in R_{VCC} should not be unacceptably high.

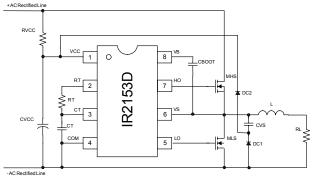


Fig. 2 Charge pump circuit

The supply resistor (R_{VCC}) must be selected such that enough supply current is available over all operating conditions.

Once the capacitor voltage on VCC reaches the start-up threshold VCCUV+, the IC turns on and HO and LO begin to oscillate.

Bootstrap MOSFET

The internal bootstrap FET and supply capacitor (C_{BOOT}) comprise the supply voltage for the high side driver circuitry. The internal boostrap FET only turns on when LO is high. To guarantee that the high-side supply is charged up before the first pulse on pin HO, the first pulse from the output drivers comes from the LO pin.

Normal operating mode

Once the VCCUV+ threshold is passed, the MOSFET M1 opens, RT increases to approximately VCC (VCC-VRT+) and the external CT capacitor starts charging. Once the CT voltage reaches VCT- (about 1/3 of VCC), established by an internal resistor ladder, LO turns on with a delay equivalent to the deadtime td. Once the CT voltage reaches VCT+ (approximately 2/3 of VCC), LO goes low, RT goes down to approximately ground (VRT-), the CT capacitor discharges and the deadtime circuit is activated. At the end of the deadtime, HO goes high. Once the CT voltage reaches VCT-, HO goes low, RT goes high again, the deadtime is activated. At the end of the deadtime, LO goes high and the cycle starts over again.

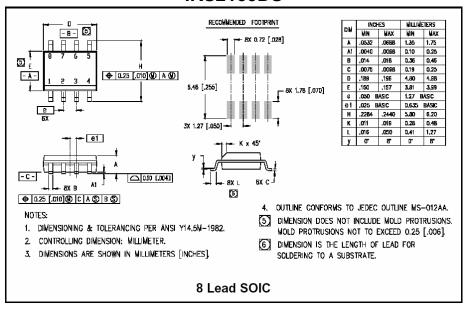
The following equation provides the oscillator frequency:

$$f = \frac{1}{2 \times \ln(2) \times RT \times CT} = \frac{1}{1.3863 \times RT \times CT}$$

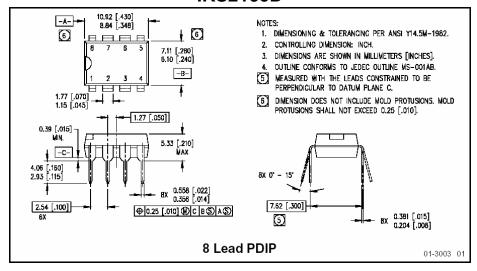
Shut-down

If CT is pulled down below V_{CTSD} (approximately 1/6 of VCC) by an external circuit, CT doesn't charge up and oscillation stops. LO is held low and the bootstrap FET is off. Oscillation will resume once CT is able to charge up again to VCT-.

IRS2153DS



IRS2153D



Qualification: Industrial, MSL3. Leadfree parts also available

International

WORLD HEADQUARTERS:

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Sales Offices, Agents and Distributors in Major Cities Throughout the World.

Data and specifications subject to change without notice 6/29/2005.